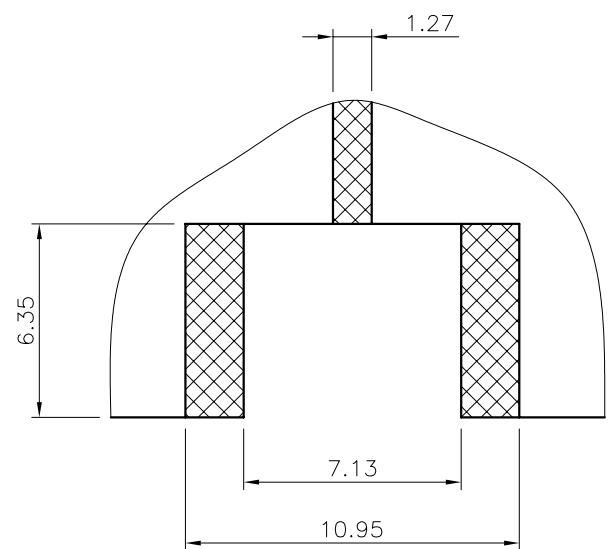
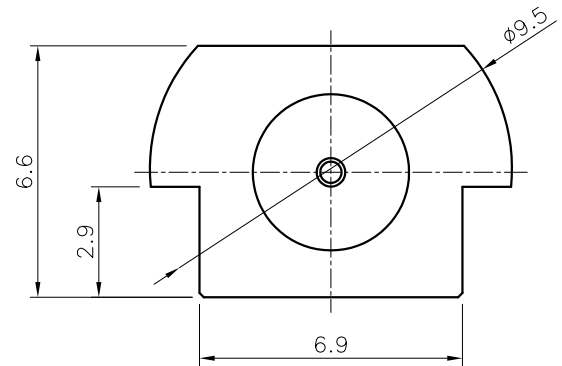
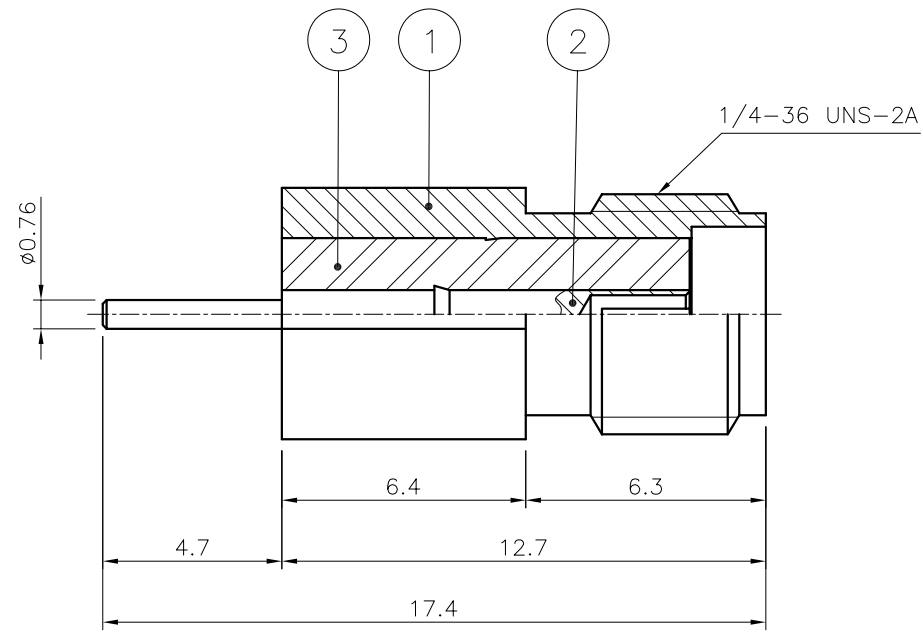


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	J.H.YOUN	2011.10.27.



RECOMMENDED LAND PATTERN

3	INSULATOR	1	TEFLON		DIN00103-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT02508-5/1
1	BODY	1	MBsBD	Gold Plate	DBD02970-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2011. 10. 27.			 COMTECH RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle	APPROVED BY	J.H.YOUN			
MATERIAL	±0.1	CHECKED BY	TITLE SMA50 PCB J-R EDGE			
	±1°	DRAWN BY				I.C.KIM
FINISH		SCALE 5/1	UNIT mm		A4	DWG NO. CN02726-7/1
						REVISION I R

A4